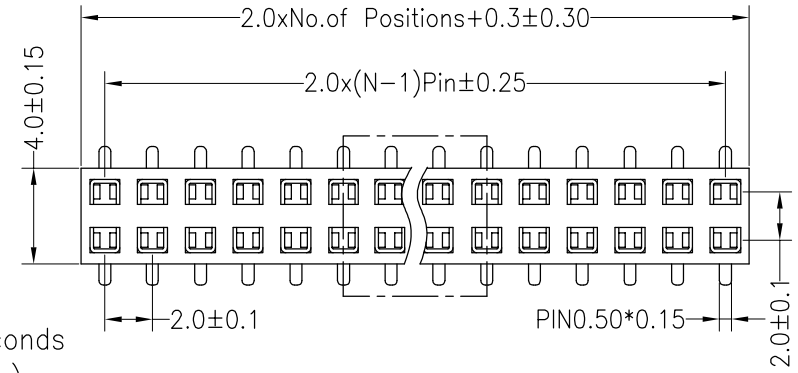
HSF RoHS

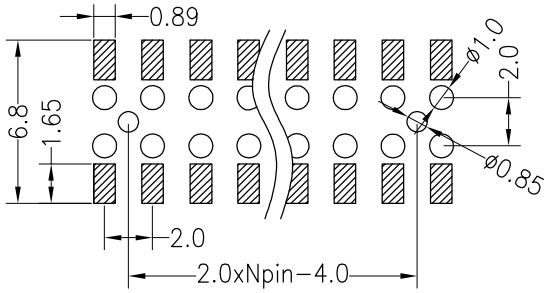
FILE NO :E362810

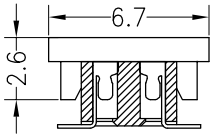
SPECIFICATIONS
Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°C to +105°C

Contact Material:Phosphor Bronze
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA9T+30%GF
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

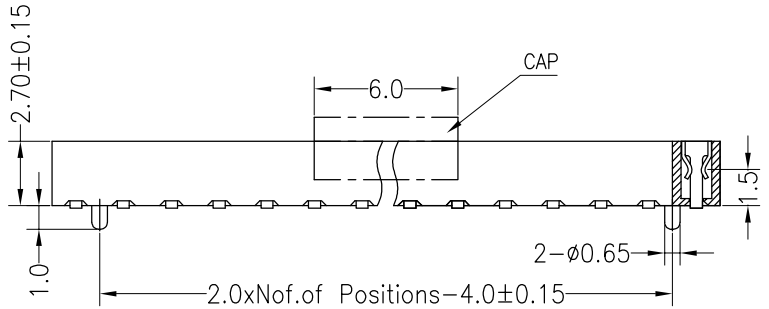


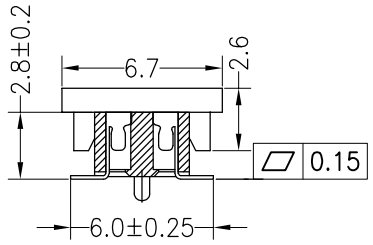
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)





N= W/O Post





W= With Post

Ordering Information

2327T 2 XX X X XX M U X 01

- No.of Pins: 2x2~2*40
- Insulator Material Option: A=BK−PBT; C=BK−PA6T; D=BK−PA46; E=BK−PA9T; F=BK−LCP
- Post: W=With Post; N=W/O Post
- Contact Plating: G0:Gold Flash; G1:3U" Gold; G2:5U" Gold; G3:10U" Gold; G4:15U" Gold; G5:30U" Gold; S0:Gold Flash/Tin; SN:Tin
- Packing: T=Tube; P=Tube+Cap; R=Reel+Cap; M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.04.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.04.18	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2327T2XXXXXXMUX01
TITLE:	2.0PF H2.7mm 2xNpin SMT Bottom Entry